

Features

- Trench LV MOSFET Technology
- ESD Protected Up To 2KV (HBM)
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

P-Channel MOSFET

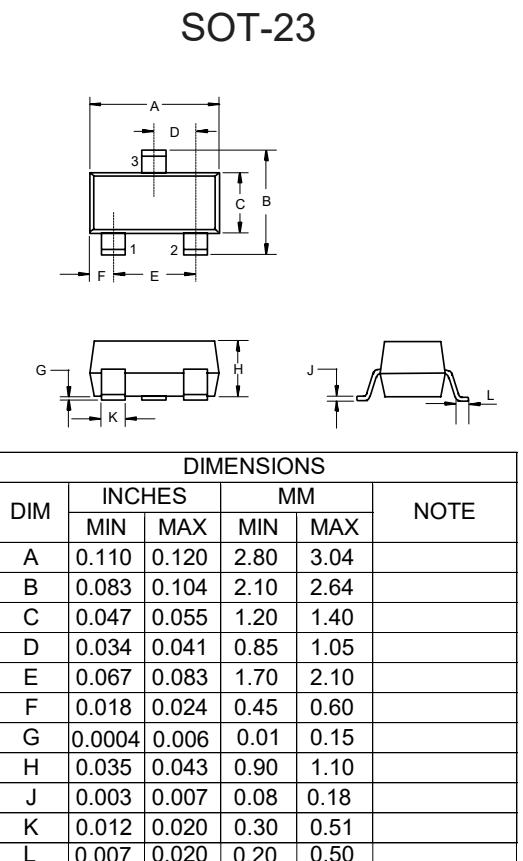
Maximum Ratings

- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 100°C/W Junction to Ambient (Note2)

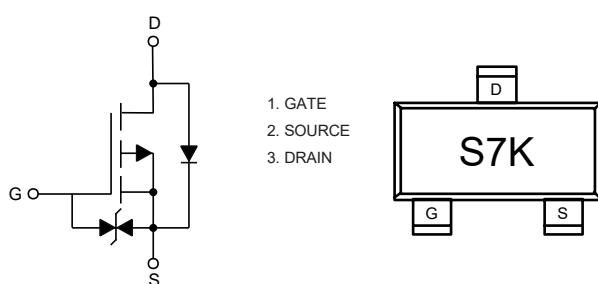
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±8	V
Continuous Drain Current <small>T_A=25°C</small>	I _D	-3	A
		-1.9	
Pulsed Drain Current ^(Note3)	I _{DM}	-12	A
Total Power Dissipation ^(Note4)	P _D	1.25	W

Note:

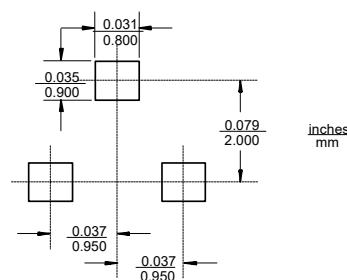
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.



Internal Structure and Marking Code



Suggested Solder Pad Layout



ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250μA	-30			V
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.4	-0.6	-1.2	V
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±8V, V _{DS} =0V			±10	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V, V _{GS} =0V			-1	μA
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-3A		60	90	mΩ
		V _{GS} =-2.5V, I _D =-1.5A		66	100	
		V _{GS} =-1.8V, I _D =-0.75A		75	115	
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D =-3A		16		s
Gate Resistance	R _g	f=1 MHz, Open drain		20		Ω
Diode Characteristics						
Continuous Body Diode Current	I _S				-3	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-3A			-1.2	V
Reverse Recovery Time	t _{rr}	I _F =-3A, dI _F /dt=100A/μs		10		ns
Reverse Recovery Charge	Q _{rr}			5		nC
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =-25V, V _{GS} =0V, f=1MHz		1060		pF
Output Capacitance	C _{oss}			46		
Reverse Transfer Capacitance	C _{rss}			29		
Total Gate Charge	Q _g	V _{DS} =-15V, V _{GS} =-4.5V, I _D =-3A		9.2		nC
Gate-Source Charge	Q _{gs}			1.1		
Gate-Drain Charge	Q _{gd}			1.0		
Turn-On Delay Time	t _{d(on)}	V _{DD} =-15V, V _{GS} =-4.5V, R _G =2.7Ω, I _D =-3A		10		ns
Turn-On Rise Time	t _r			38		
Turn-Off Delay Time	t _{d(off)}			90		
Turn-Off Fall Time	t _f			40		

Curve Characteristics

Fig.1 - Typical Output Characteristics

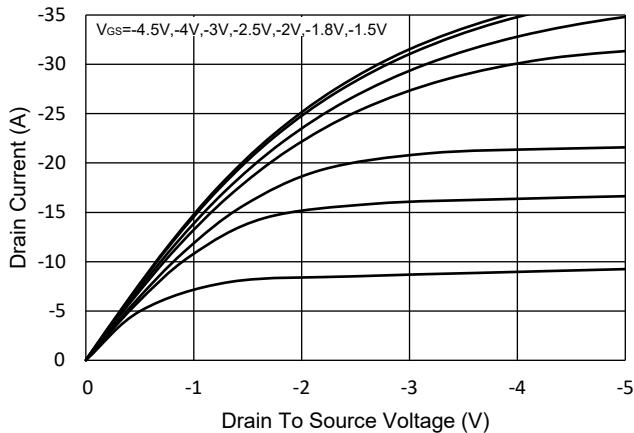


Fig.2 - Transfer Characteristic

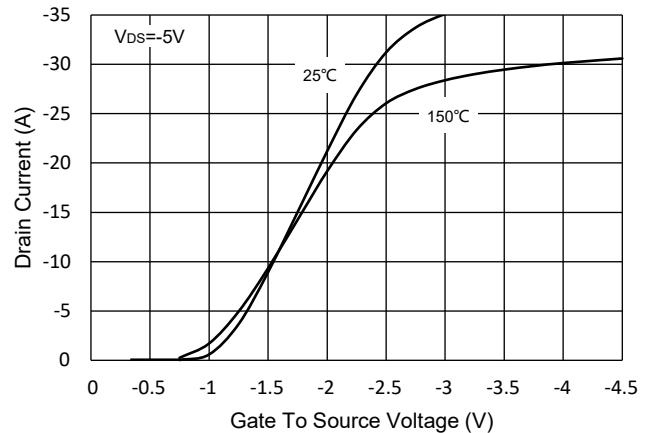


Fig.3 - $R_{DS(ON)}$ - V_{GS}

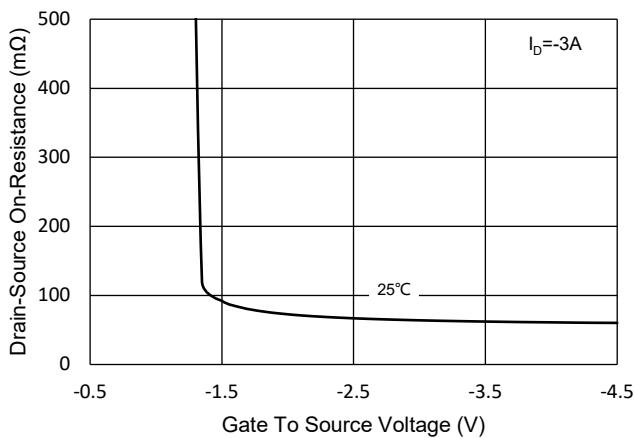


Fig.4 - $R_{DS(ON)}$ - I_D

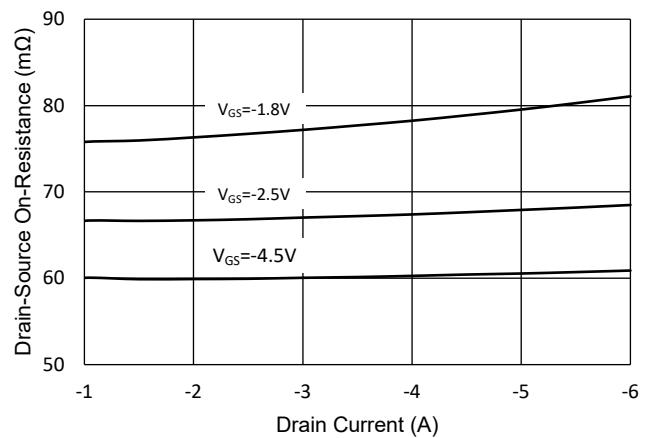


Fig.5 - Capacitance Characteristics

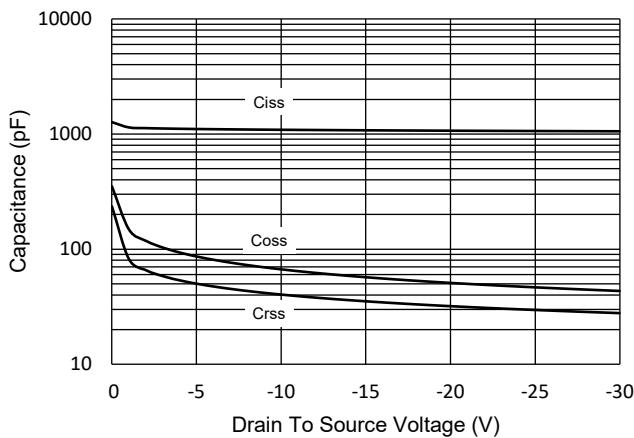
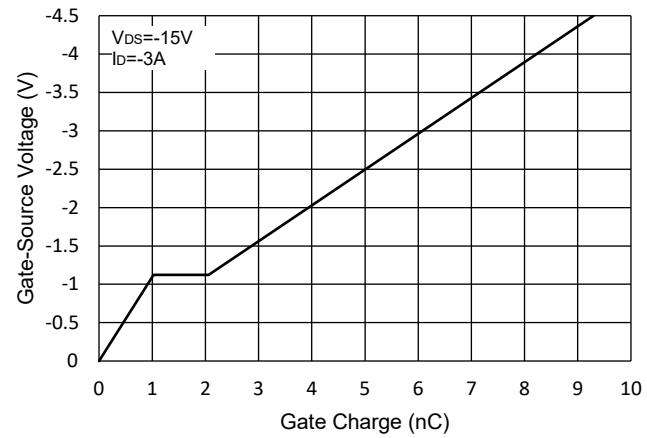


Fig.6 - Gate Charge



Curve Characteristics

Fig.7 - Normalized Threshold Voltage

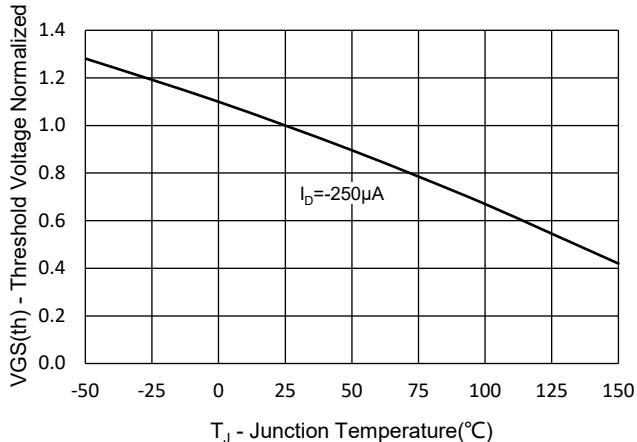


Fig.8 - Normalized On Resistance Characteristics

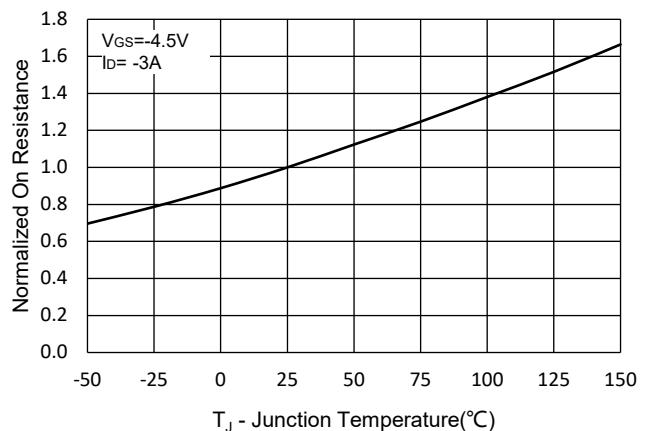


Fig.9 - I_S - V_{SD}

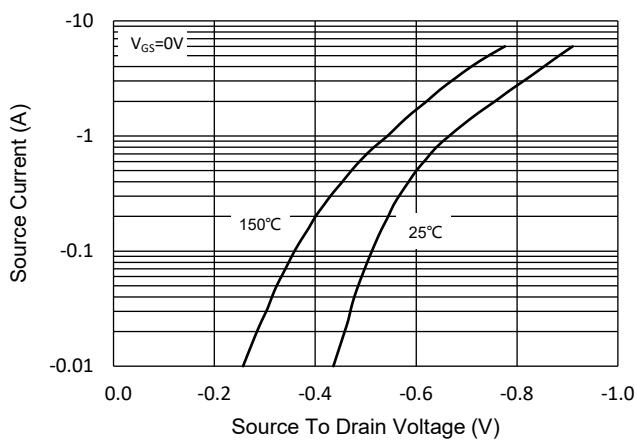


Fig.10 - Drain Current

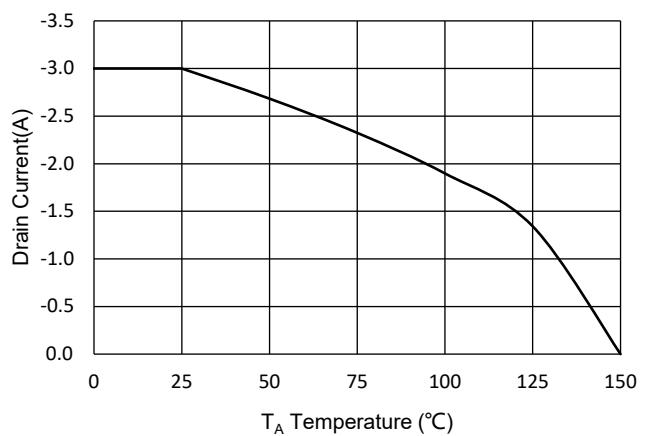
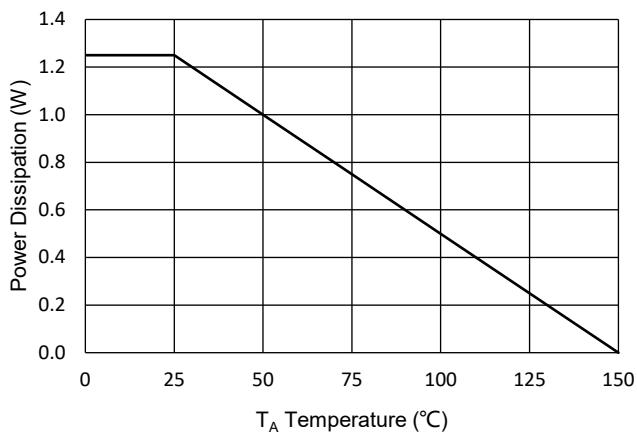


Fig.11 - PD Dissipation



Curve Characteristics

Fig.12 - Safe Operation Area

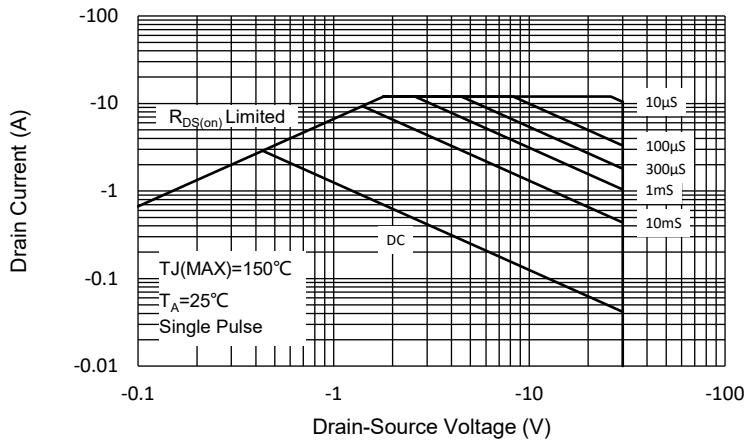
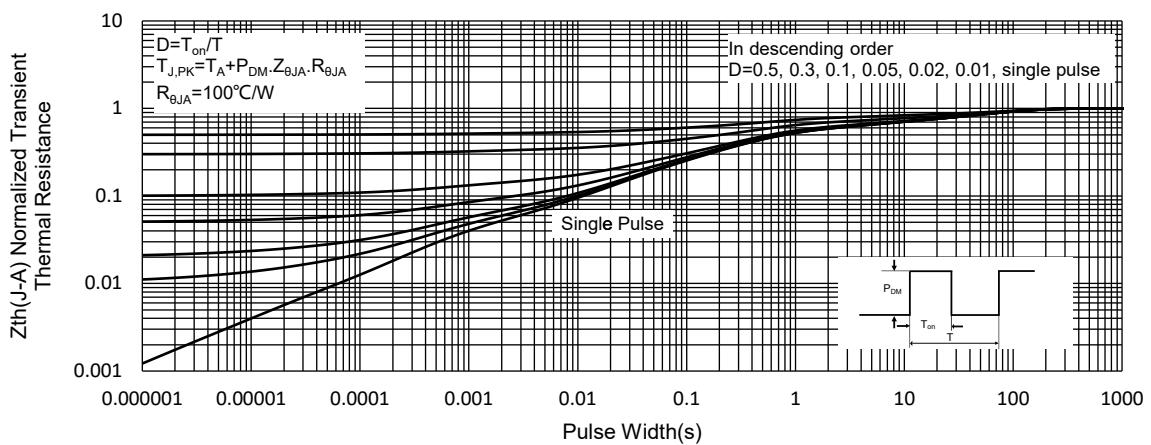


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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